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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	32
Program Memory Size	32KB (32K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.620", 15.75mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323hep4032g

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Revision History

Each instance in Table 1 reflects a change to this document from its previous revision. To see more detail, click the appropriate link in the table.

Table 1.	Revision	History	of this	Document
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Date	Revision Level	Section	Description	Page #
December 2004	02	deleted mask option and 10. Added new	consumption, STOP and HALT mode current values, note, clarified temperature ranges in Tables 6 and 8 Tables 9 and 10. Also added Characterization data to ed Program/Erase Endurance value in Table 12.	11,12,
		Removed Preliminar	y designation	All
March 2005	03	Minor change to Tab pin CDIP parts in the	le 9 Electrical Characteristics. Added 20, 28 and 40- ordering Section.	11,90





- Port 1: 0–3 pull-up transistors
- Port 1: 4–7 pull-up transistors
- Port 2: 0-7 pull-up transistors
- EPROM Protection
- WDT enabled at POR

General Description

The ZGP323H is an OTP-based member of the MCU family of infrared microcontrollers. With 237B of general-purpose RAM and up to 32KB of OTP, ZiLOG[®]'s CMOS microcontrollers offer fast-executing, efficient use of memory, sophisticated interrupts, input/output bit manipulation capabilities, automated pulse generation/reception, and internal key-scan pull-up transistors.

The ZGP323H architecture (Figure 1) is based on ZiLOG's 8-bit microcontroller core with an Expanded Register File allowing access to register-mapped peripherals, input/output (I/O) circuits, and powerful counter/timer circuitry. The Z8[®] offers a flexible I/O scheme, an efficient register and address space structure, and a number of ancillary features that are useful in many consumer, automotive, computer peripheral, and battery-operated hand-held applications.

There are three basic address spaces available to support a wide range of configurations: Program Memory, Register File and Expanded Register File. The register file is composed of 256 Bytes (B) of RAM. It includes 4 I/O port registers, 16 control and status registers, and 236 general-purpose registers. The Expanded Register File consists of two additional register groups (F and D).

To unburden the program from coping with such real-time problems as generating complex waveforms or receiving and demodulating complex waveform/pulses, the Z8 GP OTP offers a new intelligent counter/timer architecture with 8-bit and 16-bit counter/timers (see Figure 2). Also included are a large number of user-selectable modes and two on-board comparators to process analog signals with separate reference voltages.

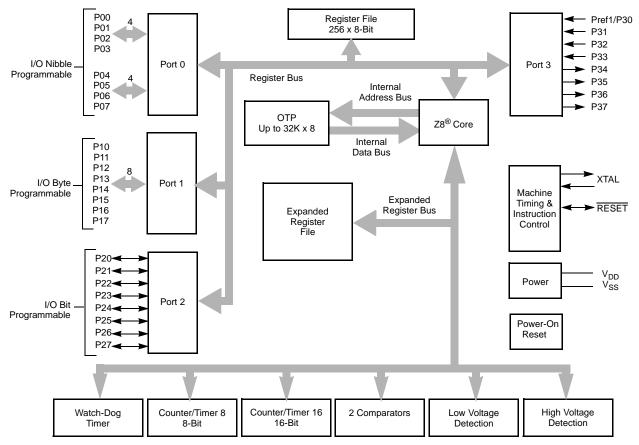
Note: All signals with an overline, "", are active Low. For example, B/W, in which WORD is active Low, and B/W, in which BYTE is active Low.

Power connections use the conventional descriptions listed in Table 3.



Table 3. Power Connections

Connection	Circuit	Device	
Power	V _{CC}	V _{DD}	
Ground	GND	V _{SS}	



Note: Refer to the specific package for available pins.

Figure 1. Functional Block Diagram



			T _A = -40°0	C to +105	°C			
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0 \text{mA}$	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
IIL	Input Leakage	2.0-5.5	-1		1	μA	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200.0		700.0	KΩ	V _{IN} = 0V; Pullups selected by mask	
		3.6V	50.0		300.0	KΩ	option	
		5.0V	25.0		175.0	KΩ	-	
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0V, V_{CC}$	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
		5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current	2.0V		0.5	1.6	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
	(HALT Mode)	3.6V		0.8	2.0	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
		5.5V		1.3	3.2	mA	V _{IN} = 0V, Clock at 8.0MHz	1, 2, 6
I _{CC2}	Standby Current (Stop	2.0V		1.6	12	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
	Mode)	3.6V		1.8	15	μA	V _{IN} = 0 V, V _{CC} WDT not Running	3
		5.5V		1.9	18	μA	$V_{IN} = 0 V, V_{CC} WDT not Running$	3
		2.0V		5	30	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6V		8	40	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		5.5V		15	60	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V_{LVD}	V _{CC} Low Voltage Detection			2.4		V		
V _{HVD}	Vcc High Voltage Detection			2.7		V		
-								

Table 10. GP323HE DC Characteristics (Continued)

Notes:

1. All outputs unloaded, inputs at rail.

2. CL1 = CL2 = 100 pF.

3. Oscillator stopped.

4. Oscillator stops when V_{CC} falls below V_{BO} limit.

 It is strongly recommended to add a filter capacitor (minimum 0.1 μF), physically close to VCC and V_{SS} pins if operating voltage fluctuations are anticipated, such as those resulting from driving an Infrared LED.

6. Comparator and Timers are on. Interrupt disabled.

7. Typical values shown are at 25 degrees C.



Table 11. GP323HA DC Characteristics

			T _A = -40°C	C to +12	5°C			
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V _{CC}	Supply Voltage		2.0		5.5	V	See Note 5	5
V _{CH}	Clock Input High Voltage	2.0-5.5	0.8 V _{CC}		V _{CC} +0.3	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.4	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0-5.5	0.7 V _{CC}		V _{CC} +0.3	V		
V _{IL}	Input Low Voltage	2.0-5.5	V _{SS} 0.3		0.2 V _{CC}	V		
V _{OH1}	Output High Voltage	2.0-5.5	V _{CC} -0.4			V	I _{OH} = -0.5mA	
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0 \text{mA}$	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
Ι _{ΙL}	Input Leakage	2.0-5.5	-1		1	μΑ	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200		700	KΩ	V _{IN} = 0V; Pullups selected by mask	(
		3.6V	50		300	KΩ	option	
		5.0V	25		175	KΩ	_	
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0V, V_{CC}$	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1,2
	0	5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current	2.0V		0.5	1.6	mA m A	$V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6
	(HALT Mode)	3.6V 5.5V		0.8 1.3	2.0 3.2	mA mA	$V_{IN} = 0V$, Clock at 8.0MHz $V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6 1, 2, 6
1	Standby Current (Stop	2.0V		1.6	15	μΑ	$V_{IN} = 0 V$, V_{CC} WDT not Running	3
I _{CC2}	Mode)	2.6V 3.6V		1.8	20	μA μA	$V_{IN} = 0 V, V_{CC} WDT not Running$ $V_{IN} = 0 V, V_{CC} WDT not Running$	3
	wode)	5.5V		1.9	25	μA	$V_{IN} = 0 V$, V_{CC} WDT not Running	3
		2.0V		5	30	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6V		8	40	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		5.5V		15	60	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V	•	



Table 11. GP323HA DC Characteristics (Continued)

	T _A = -40°C to +125°C									
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes		
V _{HVD}	Vcc High Voltage Detection			2.7		V				
Notes:										
1. All o	outputs unloaded, inpu	ıts at rail.								
2. CL1	1 = CL2 = 100 pF.									
3. Osc	cillator stopped.									
4. Osc	cillator stops when V _{CC}	falls below	V _{BO} limit.							
volt	age fluctuations are a	nticipated, su	ch as thos	e resulting			cally close to VCC and nfrared LED.	V_{SS} pins if operating		
6. Cor	mparator and Timers a	re on. Interru	pt disabled	1.						

7. Typical values shown are at 25 degrees C.

Table 12. EPROM/OTP Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Unit	Notes
	Erase Time	15			Minutes	1,3
	Data Retention @ use years		10		Years	2
	Program/Erase Endurance	100			Cycles	1

Notes:

1. For windowed cerdip package only.

2. Standard: 0°C to 70°C; Extended: -40°C to +105°C; Automotive: -40°C to +125°C. Determined using the Arrhenius model, which is an industry standard for estimating data retention of floating gate technologies:

AF = exp[(Ea/k)*(1/Tuse - 1/TStress)] Where: Ea is the intrinsic activation energy (eV; typ. 0.8) k is Boltzman's constant (8.67 x 10-5 eV/°K) °K = -273.16°C Tuse = Use Temperature in °K TStress = Stress Temperature in °K 3. At a stable UV Lamp output of 20mW/CM²



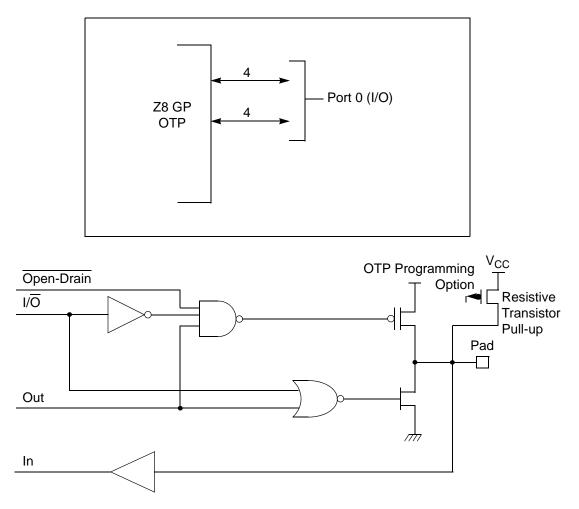


Figure 9. Port 0 Configuration

Port 1 (P17–P10)

Port 1 (see Figure 10) Port 1 can be configured for standard port input or output mode. After POR, Port 1 is configured as an input port. The output drivers are either push-pull or open-drain and are controlled by bit D1 in the PCON register.



Note: The Port 1 direction is reset to its default state following an SMR.





Z8 [®] Standard (Control Registers	Reset Condition
	Expanded Reg. Bank 0/Group 15	** D7 D6 D5 D4 D3 D2 D1 D0
	FF SPL	
	FE SPH	
Register Pointer	FD RP	0 0 0 0 0 0 0 0
7 6 5 4 3 2 1 0	FC FLAGS	
	FB IMR	
Working Register Expanded Regist	er FA IRQ	0 0 0 0 0 0 0 0
Group Pointer Bank Pointer	F9 IPR	
	F8 P01M	1 1 0 0 1 1 1 1
	* F7 P3M	000000000
	* F6 P2M	
	F5 Reserved	
	F4 Reserved	
X	F3 Reserved F2 Reserved	
Register File (Bank 0)**		
FF F0		
	F0 Reserved	
	Expanded Reg. Bank F/Group 0**	×
	(F) OF WDTMR	
	(F) 0E Reserved	
	* (F) 0D_SMR2	0 0 0 0 0 0 0 0
	(F) 0C Reserved	
	(F) 0B_SMR	
7F	(F) 0A Reserved	
	(F) 09 Reserved	┫┣╌┽┽┽┽┽┽┽┥╴
	(F) 08 Reserved	┫┝┼┼┼┼┼┼┼┥
	(F) 07 Reserved	╢┝┼┼┼┼┼┼┼┤
	(F) 06 Reserved	┫┝┼┼┼┼┼┼┼┥
	(F) 05 Reserved	
₀₅┝─────₽₽∕	(F) 04 Reserved	
	(F) 03 Reserved	
	(F) 02 Reserved	
	(F) 01 Reserved	┨┠┼┼┼┼┼┼┼┥
Expanded Reg. Bank 0/Group (0)	(F) 00 PCON	
	Expanded Reg. Bank D/Group 0	, <u>, , , , , , , , , , , , , , , , , , </u>
(0) 03 P3 0 U	(D) OC LVD	
(0) 02 P2 U	* (D) 0B HI8	00000000
* (0) 01 P1 U	* (D) 0A LO8	00000000
	* (D) 09 HI16	000000000
(0) 00 P0 U	* (D) 08 LO16	000000000
U = Unknown	* (D) 07 TC16H	0 0 0 0 0 0 0 0
* Is not reset with a Stop-Mode Recovery	* (D) 06 TC16L	00000000
** All addresses are in hexadecimal	* (D) 05 TC8H	00000000
↑ Is not reset with a Stop-Mode Recovery, except Bit 0	* (D) 04 TC8L	0 0 0 0 0 0 0 0
↑↑ Bit 5 Is not reset with a Stop-Mode Recovery	1↑ (D) 03 CTR3	0 0 0 1 1 1 1 1
↑↑↑ Bits 5,4,3,2 not reset with a Stop-Mode Recovery	↑↑↓ (D) 02 CTR2	000000000
↑↑↑↑ Bits 5 and 4 not reset with a Stop-Mode Recovery	↑↑↑↑ (D) 01 CTR1	0 0 0 0 0 0 0 0
↑↑↑↑↑ Bits 5,4,3,2,1 not reset with a Stop-Mode Recovery	↑↑↑↑↑ (D) 00 CTR0	000000000

Figure 15. Expanded Register File Architecture



Field	Bit Position		Value	Description
Transmit_Submode/	32	R/W		Transmit Mode
Glitch_Filter			00*	Normal Operation
			01	Ping-Pong Mode
			10	T16_Out = 0
			11	T16_Out = 1
				Demodulation Mode
			00*	No Filter
			01	4 SCLK Cycle
			10	8 SCLK Cycle
			11	Reserved
Initial_T8_Out/	1-			Transmit Mode
Rising Edge		R/W	0*	T8_OUT is 0 Initially
			1	T8_OUT is 1 Initially
				Demodulation Mode
		R	0*	No Rising Edge
			1	Rising Edge Detected
		W	0	No Effect
			1	Reset Flag to 0
Initial_T16_Out/	0			Transmit Mode
Falling_Edge		R/W	0*	T16_OUT is 0 Initially
			1	T16_OUT is 1 Initially
				Demodulation Mode
		R	0*	No Falling Edge
			1	Falling Edge Detected
		W	0	No Effect
			1	Reset Flag to 0

Table 16.CTR1(0D)01H T8 and T16 Common Functions (Continued)

Note:

*Default at Power-On Reset

*Default at Power-On Reset. Not reset with Stop Mode recovery.

Mode

If the result is 0, the counter/timers are in TRANSMIT mode; otherwise, they are in DEMODULATION mode.

P36_Out/Demodulator_Input

In TRANSMIT Mode, this bit defines whether P36 is used as a normal output pin or the combined output of T8 and T16.

In DEMODULATION Mode, this bit defines whether the input signal to the Counter/Timers is from P20 or P31.

If the input signal is from Port 31, a capture event may also generate an IRQ2 interrupt. To prevent generating an IRQ2, either disable the IRQ2 interrupt by clearing its IMR bit D2 or use P20 as the input.



Field	Bit Position		Value	Description
T16_Enable	7	R	0*	Counter Disabled
			1	Counter Enabled
		W	0	Stop Counter
			1	Enable Counter
Single/Modulo-N	-6	R/W		Transmit Mode
			0*	Modulo-N
			1	Single Pass
				Demodulation Mode
			0	T16 Recognizes Edge
			1	T16 Does Not Recognize
				Edge
Time_Out	5	R	0*	No Counter Timeout
			1	Counter Timeout
				Occurred
		W	0	No Effect
			1	Reset Flag to 0
T16 _Clock	43	R/W	00**	SCLK
			01	SCLK/2
			10	SCLK/4
			11	SCLK/8
Capture_INT_Mask	2	R/W	0**	Disable Data Capture Int.
			1	Enable Data Capture Int.
Counter_INT_Mask	1-	R/W	0*	Disable Timeout Int.
				Enable Timeout Int.
P35_Out	0	R/W	0*	P35 as Port Output
			1	T16 Output on P35

Table 17. CTR2(D)02H: Counter/Timer16 Control Register

Note:

*Indicates the value upon Power-On Reset.

**Indicates the value upon Power-On Reset. Not reset with a Stop Mode recovery.

T16_Enable

This field enables T16 when set to 1.

Single/Modulo-N

In TRANSMIT Mode, when set to 0, the counter reloads the initial value when it reaches the terminal count. When set to 1, the counter stops when the terminal count is reached.



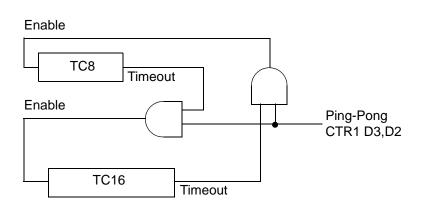


Figure 28. Ping-Pong Mode Diagram

Initiating PING-PONG Mode

First, make sure both counter/timers are not running. Set T8 into Single-Pass mode (CTR0, D6), set T16 into SINGLE-PASS mode (CTR2, D6), and set the Ping-Pong mode (CTR1, D2; D3). These instructions can be in random order. Finally, start PING-PONG mode by enabling either T8 (CTR0, D7) or T16 (CTR2, D7). See Figure 29.





The initial value of T8 or T16 must not be 1. Stopping the timer and restarting the timer reloads the initial value to avoid an unknown previous value.



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SMR(0F)0BH



* Default after Power On Reset or Watch-Dog Reset

* * Default setting after Reset and Stop Mode Recovery

* * * At the XOR gate input

* * * * Default setting after reset. Must be 1 if using a crystal or resonator clock source.

Figure 33. STOP Mode Recovery Register

SCLK/TCLK Divide-by-16 Select (D0)

D0 of the SMR controls a divide-by-16 prescaler of SCLK/TCLK (Figure 34). This control selectively reduces device power consumption during normal processor execution (SCLK control) and/or Halt Mode (where TCLK sources interrupt logic). After Stop Mode Recovery, this bit is set to a 0.



Stop Mode Recovery Register 2 (SMR2)

This register determines the mode of Stop Mode Recovery for SMR2 (Figure 36).

SMR2(0F)DH

D7	D6	D5	D4	D3	D2	D1	D0	
								 Reserved (Must be 0) Reserved (Must be 0) Stop-Mode Recovery Source 2 000 POR Only * 001 NAND P20, P21, P22, P23 010 NAND P20, P21, P22, P23, P24, P25, P26, P27 011 NOR P31, P32, P33 100 NAND P31, P32, P33 101 NOR P31, P32, P33, P00, P07 110 NAND P31, P32, P33, P00, P07 111 NAND P31, P32, P33, P20, P21, P22
								Reserved (Must be 0)
								Recovery Level * * 0 Low * 1 High
								Reserved (Must be 0)

Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

* * At the XOR gate input

Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only)

If SMR2 is used in conjunction with SMR, either of the specified events causes a Stop Mode Recovery.



Note: Port pins configured as outputs are ignored as an SMR or SMR2 recovery source. For example, if the NAND or P23–P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23–P21) form the NAND equation.



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CTR2(0D)02H

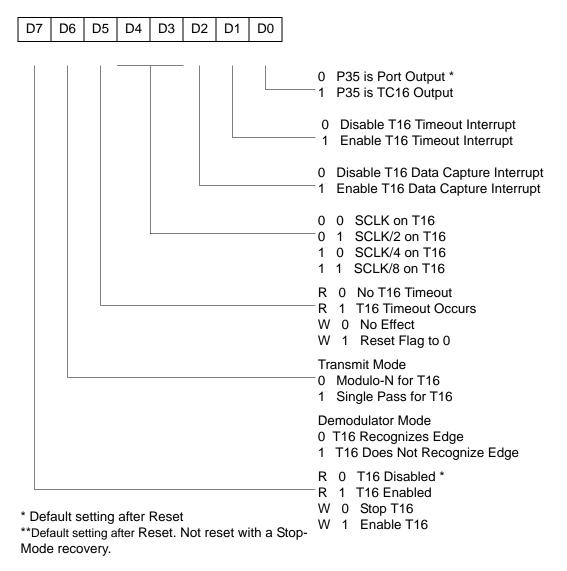


Figure 41. T16 Control Register ((0D) 2H: Read/Write Except Where Noted)





CTR3(0D)03H

D7	D6	D5	D4	D3	D2	D1	D0	
								Reserved No effect when written Always reads 11111 Sync Mode 0* Disable Sync Mode** 1 Enable Sync Mode T ₈ Enable R 0* T ₈ Disabled R 1 T ₈ Enabled W0 Stop T ₈
								W1 Enable T_8 T_{16} Enable $R 0^* T_{16}$ Disabled $R 1 T_{16}$ Enabled $W 0$ Stop T_{16} $W 1$ Enable T_{16}

* Default setting after reset. ** Default setting after reset. Not reset with a Stop Mode recovery.

Figure 42. T8/T16 Control Register (0D)03H: Read/Write (Except Where Noted)



LVD(0D)0CH



* Default setting after reset.

Figure 43. Voltage Detection Register

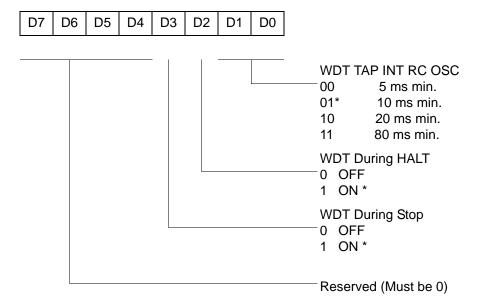
Note: Do not modify register P01M while checking a low-voltage condition. Switching noise of both ports 0 and 1 together might trigger the LVD flag.

Expanded Register File Control Registers (0F)

The expanded register file control registers (0F) are depicted in Figures 44 through Figure 57.



WDTMR(0F)0FH

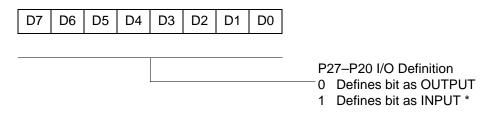


* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 47. Watch-Dog Timer Register ((0F) 0FH: Write Only)

Standard Control Registers

R246 P2M(F6H)

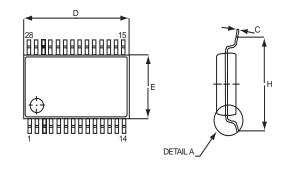


* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 48. Port 2 Mode Register (F6H: Write Only)







¥	≜ A
	A2 A

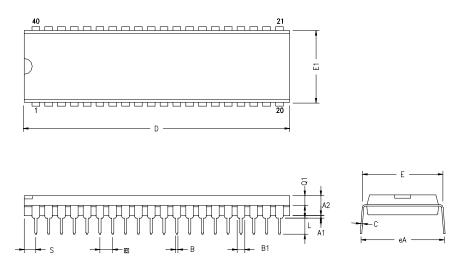
SYMBOL		MILLIMETER	2	INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
А	1.73	1.86	1.99	0.068	0.073	0.078
A1	0.05	0.13	0.21	0.002	0.005	0.008
A2	1.68	1.73	1.78	0.066	0.068	0.070
В	0.25		0.38	0.010		0.015
С	0.09	-	0.20	0.004	0.006	0.008
D	10.07	10.20	10.33	0.397	0.402	0.407
E	5.20	5.30	5.38	0.205	0.209	0.212
е	0.65 TYP		0.0256 TYP			
Н	7.65	7.80	7.90	0.301	0.307	0.311
L	0.63	0.75	0.95	0.025	0.030	0.037

CONTROLLING DIMENSIONS: MM LEADS ARE COPLANAR WITHIN .004 INCHES.

<u>DETAIL 'A'</u>

0-8

Figure 65. 28-Pin SSOP Package Diagram



SYMBOL	MILLIN	IETER	INCH		
STMDUL	MIN	MAX	MIN	MAX	
A1	0.51	1.02	.020	.040	
A2	3.18	3.94	.125	.155	
В	0.38	0.53	.015	.021	
B1	1.02	1.52	.040	.060	
С	0.23	0.38	.009	.015	
D	52.07	52.58	2.050	2.070	
E	15.24	15.75	.600	.620	
E1	13.59	14.22	.535	.560	
e	2.54	TYP	.100 TYP		
eA	15.49	16.76	.610	.660	
L	3.05	3.81	.120	.150	
Q1	1.40	1.91	.055	.075	
S	1.52	2.29	.060	.090	

CONTROLLING DIMENSIONS : INCH

Figure 66. 40-Pin PDIP Package Diagram





8KB Standard Temperature: 0° to +70°C

Part Number	Description	Part Number	Description
ZGP323HSH4808C	48-pin SSOP 8K OTP	ZGP323HSS2808C	28-pin SOIC 8K OTP
ZGP323HSP4008C	40-pin PDIP 8K OTP	ZGP323HSH2008C	20-pin SSOP 8K OTP
ZGP323HSH2808C	28-pin SSOP 8K OTP	ZGP323HSP2008C	20-pin PDIP 8K OTP
ZGP323HSP2808C	28-pin PDIP 8K OTP	ZGP323HSS2008C	20-pin SOIC 8K OTP

8KB Extended Temperature: -40° to +105°C

-			
Part Number	Description	Part Number	Description
ZGP323HEH4808C	48-pin SSOP 8K OTP	ZGP323HES2808C	28-pin SOIC 8K OTP
ZGP323HEP4008C	40-pin PDIP 8K OTP	ZGP323HEH2008C	20-pin SSOP 8K OTP
ZGP323HEH2808C	28-pin SSOP 8K OTP	ZGP323HEP2008C	20-pin PDIP 8K OTP
ZGP323HEP2808C	28-pin PDIP 8K OTP	ZGP323HES2008C	20-pin SOIC 8K OTP

8KB Automotive Temperature: -40° to +125°C

Part Number	Description	Part Number	Description
ZGP323HAH4808C	48-pin SSOP 8K OTP	ZGP323HAS2808C	28-pin SOIC 8K OTP
ZGP323HAP4008C	40-pin PDIP 8K OTP	ZGP323HAH2008C	20-pin SSOP 8K OTP
ZGP323HAH2808C	28-pin SSOP 8K OTP	ZGP323HAP2008C	20-pin PDIP 8K OTP
ZGP323HAP2808C	28-pin PDIP 8K OTP	ZGP323HAS2008C	20-pin SOIC 8K OTP
Replace C with G for	r Lead-Free Packaging		